

- **EPIC™** (Enhanced-Performance Implanted CMOS) 2-μ Process
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8\text{ V}$  at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $> 2\text{ V}$  at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model ( $C = 200\text{ pF}$ ,  $R = 0$ )
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs

## description

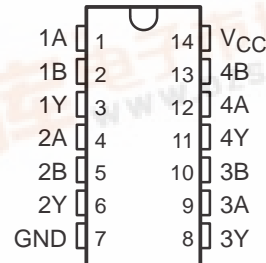
These quadruple 2-input positive-OR gates are designed for 2.7-V to 5.5-V  $V_{CC}$  operation.

The 'LV32 perform the Boolean function  $Y = A + B$  or  $Y = \overline{A} \cdot \overline{B}$  in positive logic.

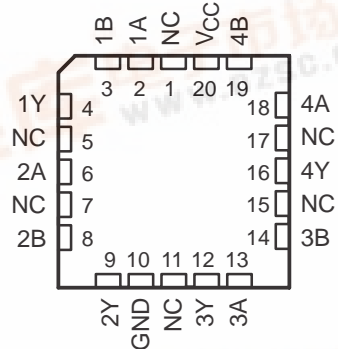
The SN74LV32 is packaged in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54LV32 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74LV32 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54LV32 ... J OR W PACKAGE  
 SN74LV32 ... D, DB, OR PW PACKAGE  
 (TOP VIEW)



SN54LV32 ... FK PACKAGE  
 (TOP VIEW)



NC – No internal connection

FUNCTION TABLE  
 (each gate)

INPUTS		OUTPUT Y
A	B	
H	X	H
X	H	H
L	L	L

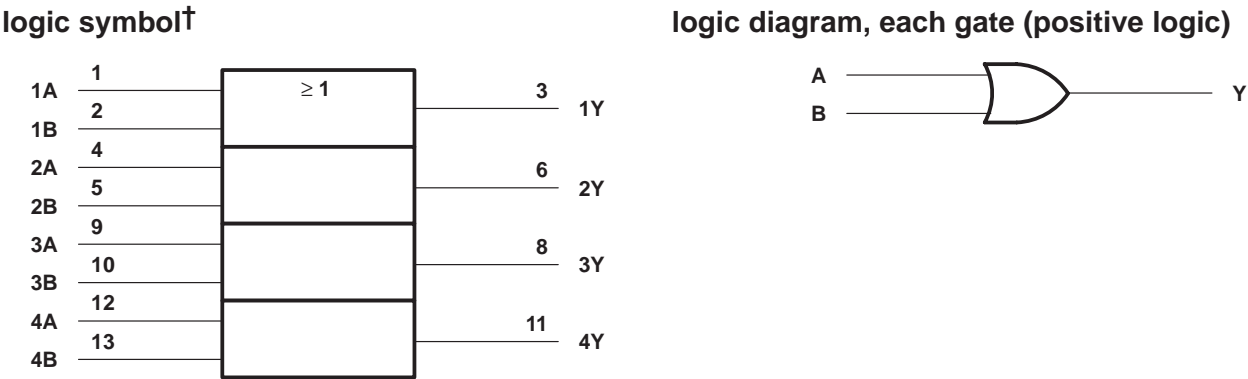
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

# SN54LV32, SN74LV32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

SCLS188C – FEBRUARY 1993 – REVISED APRIL 1996



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for D, DB, J, PW, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	$\pm 25$ mA
Continuous current through $V_{CC}$ or GND	$\pm 50$ mA
Maximum power dissipation at $T_A = 55^{\circ}\text{C}$ (in still air) (see Note 3): D package	1.25 W
DB or PW package	0.5 W
Storage temperature range, $T_{stg}$	–65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  2. This value is limited to 7 V maximum.
  3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

# SN54LV32, SN74LV32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

SCLS188C – FEBRUARY 1993 – REVISED APRIL 1996

## recommended operating conditions (see Note 4)

			SN54LV32		SN74LV32		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		2.7	5.5	2.7	5.5	V
$V_{IH}$	High-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		2		V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	3.15		3.15		
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		0.8	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.65		1.65	
$V_I$	Input voltage		0	$V_{CC}$	0	$V_{CC}$	V
$V_O$	Output voltage		0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12		-12	
$I_{OL}$	Low-level output current	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		6		6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		12		12	
$\Delta t/\Delta v$	Input transition rise or fall rate		0	100	0	100	ns/V
$T_A$	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V <sub>CC</sub> <sup>†</sup>	SN54LV32			SN74LV32			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V <sub>OH</sub>	I <sub>OH</sub> = −100 μA		MIN to MAX	V <sub>CC</sub> −0.2			V <sub>CC</sub> −0.2			V
	I <sub>OH</sub> = −6 mA		3 V	2.4			2.4			
	I <sub>OH</sub> = −12 mA		4.5 V	3.6			3.6			
V <sub>OL</sub>	I <sub>OL</sub> = 100 μA		MIN to MAX	0.2			0.2			V
	I <sub>OL</sub> = 6 mA		3 V	0.4			0.4			
	I <sub>OL</sub> = 12 mA		4.5 V	0.55			0.55			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND		3.6 V	±1			±1			μA
			5.5 V	±1			±1			
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	I <sub>O</sub> = 0	3.6 V	20			20			μA
			5.5 V	20			20			
ΔI <sub>CC</sub>	One input at V <sub>CC</sub> − 0.6 V	One input at V <sub>CC</sub> − 0.6 V	3 V to 3.6 V	500			500			μA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND		3.3 V	2.5			2.5			pF
			5 V	2			2			

$^\dagger$  For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

## switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LV32								UNIT
			V <sub>CC</sub> = 5 V ± 0.5 V			V <sub>CC</sub> = 3.3 V ± 0.3 V			V <sub>CC</sub> = 2.7 V		
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	MAX	
t <sub>pd</sub>	A	Y	6 10			9 13			16		ns

SN54LV32, SN74LV32  
QUADRUPL 2-INPUT POSITIVE-OR GATES

SCLS188C – FEBRUARY 1993 – REVISED APRIL 1996

switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$   
(unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74LV32							UNIT	
			V <sub>CC</sub> = 5 V ± 0.5 V			V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V			
			MIN	TYP	MAX	MIN	TYP	MAX	MIN		MAX
t <sub>pd</sub>	A	Y		6	10		9	13		16	ns

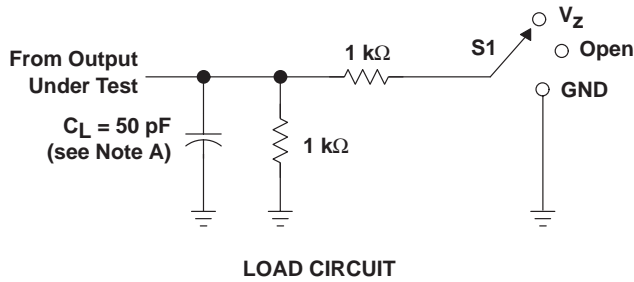
operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC}$	TYP	UNIT
$C_{pd}$	Power dissipation capacitance per gate	$C_L = 50\text{ pF}, \quad f = 10\text{ MHz}$	3.3 V	23	pF
			5 V	27	

# SN54LV32, SN74LV32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

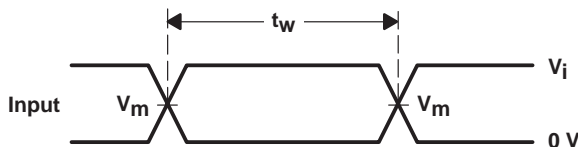
SCLS188C – FEBRUARY 1993 – REVISED APRIL 1996

## PARAMETER MEASUREMENT INFORMATION

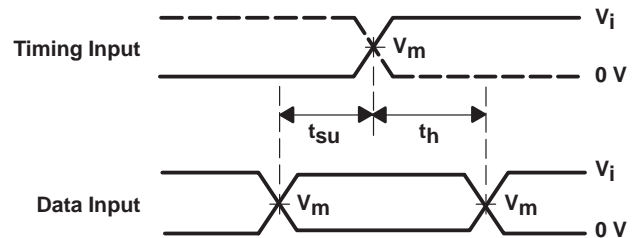


TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$V_Z$
$t_{PHZ}/t_{PZH}$	GND

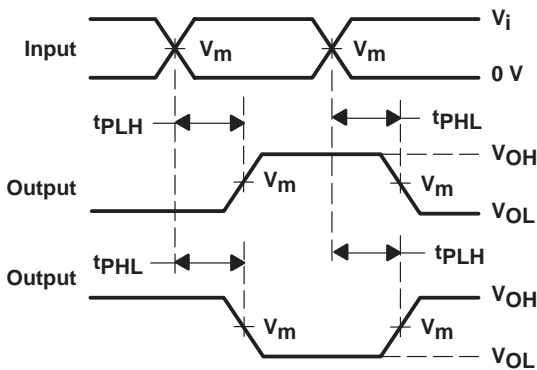
WAVEFORM CONDITION	$V_{CC} = 4.5 \text{ V}$ to 5.5 V	$V_{CC} = 2.7 \text{ V}$ to 3.6 V
$V_m$	$0.5 \times V_{CC}$	1.5 V
$V_i$	$V_{CC}$	2.7 V
$V_Z$	$2 \times V_{CC}$	6 V



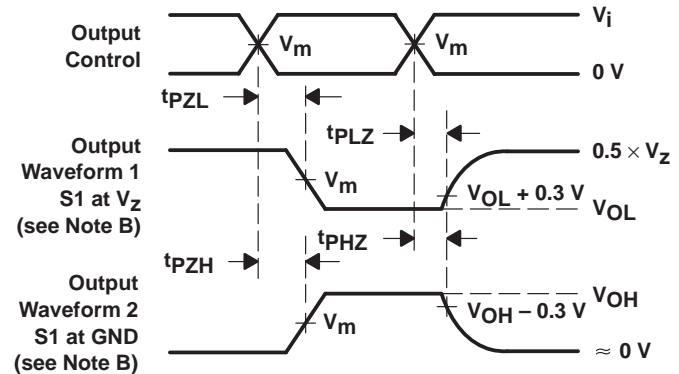
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

## **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.